

FW

SEP 14 2004

DOCKET No.: 122302.00001

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Oliver Chyan, et al.

Serial No.: 10/600,039

Filed: June 20, 2003

Art Unit: 2818

Examiner: Mai Huong C. Tran

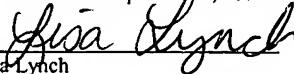
For: **METHOD OF USING MATERIALS BASED ON RUTHENIUM AND IRIDIUM AND THEIR OXIDES, AS A CU DIFFUSION BARRIER, AND INTEGRATED CIRCUITS INCORPORATING THE SAME**

Mail Stop Amendment
Commissioner of Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

CERTIFICATE OF MAILING UNDER 37 C.F.R. 1.8

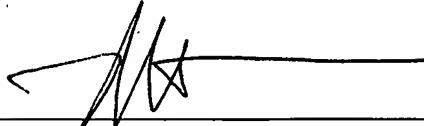
I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on September 9, 2004.


Lisa Lynch

RESPONSE TO RESTRICTION REQUIREMENT

In response to the Office Action mailed August 17, 2004, Applicant hereby elects, without traverse, to prosecute in this application Claims 1-38, comprising Group II, drawn to a process of making a semiconductor device.

Respectfully submitted,



Michael G. Cameron
Reg. No. 50,298
Jackson Walker L.L.P.
2435 North Central Expressway, Suite 600
Richardson, Texas 75080
Tel: (972) 744-2934
Fax: (972) 238-3334 or (972) 744-2909

September 9, 2004

Date